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# G3VM-41GR5 

## MOS FET Relays

## MOS FET Relays with Low Output Capacitance and ON Resistance ( $\mathbf{C} \times \mathbf{R}=$ $10 \mathrm{pF} \cdot \Omega$ ) in a $40-\mathrm{V}$ Load Voltage Model.

- ON resistance of $1 \Omega$ (typical) suppresses output signal attenuation.
- Leakage current of 1.0 nA max. when output relay is open.

RoHS compliant

Note: The actual product is marked differently from the image shown here.

## ■Application Examples

- Semiconductor test equipment
- Test \& Measurement equipment
- Communication equipment
- Data loggers


## Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here. * The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

## List of Models

| Package type | Contact form | Terminals | Load voltage <br> (peak value) $*$ | Model | Minimum package quantity |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |
| SOP4 | 1a <br> (SPST-NO) | Surface-mounting Terminals | 40 V | G3VM-41GR5 | 100 | - |
|  |  | G3VM-41GR5 (TR) | - | 2,500 |  |  |

* The AC peak and DC value are given for the load voltage.


## Absolute Maximum Ratings $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$

| Item | Symbol | Rating | Unit | Measurement conditions |
| :---: | :---: | :---: | :---: | :---: |
| LED forward current | IF | 50 | mA |  |
| \# LED forward current reduction rate | $\Delta \mathrm{F} /{ }^{\circ} \mathrm{C}$ | -0.5 | $\mathrm{mA} /{ }^{\circ} \mathrm{C}$ | $\mathrm{Ta} \geq 25^{\circ} \mathrm{C}$ |
| 드 LED reverse voltage | VR | 5 | V |  |
| Connection temperature | TJ | 125 | ${ }^{\circ} \mathrm{C}$ |  |
| L Load voltage (AC peak/DC) | Voff | 40 | V |  |
| 亏 Continuous load current (AC peakDC) | 10 | 300 | mA |  |
| O\% ON current reduction rate | $\Delta \mathrm{lo} /{ }^{\circ} \mathrm{C}$ | -3.0 | $\mathrm{mA} /{ }^{\circ} \mathrm{C}$ | $\mathrm{Ta} \geq 25^{\circ} \mathrm{C}$ |
| O Connection temperature | TJ | 125 | ${ }^{\circ} \mathrm{C}$ |  |
| Dielectric strength between I/O (See note 1.) | Vi-O | 1500 | Vrms | AC for 1 min |
| Ambient operating temperature | Ta | -20 to +85 | ${ }^{\circ} \mathrm{C}$ | With no icing or condensation |
| Ambient storage temperature | Tstg | -40 to +125 | ${ }^{\circ} \mathrm{C}$ | With no icing or condensation |
| Soldering temperature | - | 260 | ${ }^{\circ} \mathrm{C}$ | 10 s |

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

Electrical Characteristics $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$

| Item | Symbol | Minimum | Typical | Maximum | Unit | Measurement conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED forward voltage | $\mathrm{V}_{\mathrm{F}}$ | 1.0 | 1.15 | 1.3 | V | $\mathrm{IF}=10 \mathrm{~mA}$ |
| $\underset{7}{7}$ Reverse current | IR | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ |
| 드 Capacity between terminals | Ст | - | 15 | - | pF | $\mathrm{V}=0, \mathrm{f}=1 \mathrm{MHz}$ |
| Trigger LED forward current | IFT | - | - | 4 | mA | $\mathrm{lo}=100 \mathrm{~mA}$ |
| $\pm$ Maximum resistance with output ON | Ron | - | 1.0 | 1.5 | $\Omega$ | $\mathrm{lf}=5 \mathrm{~mA}, \mathrm{lo}=300 \mathrm{~mA}, \mathrm{t}<1 \mathrm{~s}$ |
| 윽 Current leakage when the relay is open | ILEAK | - | - | 1.0 | nA | Voff $=30 \mathrm{~V}, \mathrm{Ta}=50^{\circ} \mathrm{C}$ |
| 0 Capacity between terminals | Coff | - | 10 | 14 | pF | $\mathrm{V}=0, \mathrm{f}=100 \mathrm{MHz}, \mathrm{t}<1 \mathrm{~s}$ |
| Capacity between I/O terminals | Cl-O | - | 0.8 | - | pF | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{Vs}=0 \mathrm{~V}$ |
| Insulation resistance between //0 terminals | Ri-o | 1000 | - | - | $\mathrm{M} \Omega$ | V I-O $=500 \mathrm{VDC}, \mathrm{RoH} \leq 60 \%$ |
| Turn-ON time | ton | - | - | 0.5 | ms | $\mathrm{IF}=10 \mathrm{~mA}, \mathrm{RL}=200 \Omega$, |
| Turn-OFF time | toff | - | - | 0.5 | ms | Vdd $=20 \mathrm{~V}$ (See note 2.) |

Note: 2. Turn-ON and Turn-OFF Times


## Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

| Item | Symbol | Minimum | Typical | Maximum | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Load voltage (AC peak/DC) | VDD | - | - | 32 | V |
| Operating LED forward current | IF | 10 | - | 30 | mA |
| Continuous load current (AC peak/DC) | lo | - | - | 300 | mA |
| Ambient operating temperature | Ta | 25 | - | 60 | ${ }^{\circ} \mathrm{C}$ |

## ■ Engineering Data

LED forward current vs. Ambient temperature


Continuous load current vs. On-state voltage


Turn ON, Turn OFF time vs. LED forward current


Output terminal capacitance vs. Load voltage


Continuous load current vs. Ambient temperature


On-state resistance vs. Ambient temperature
Ron - Ta


Turn ON, Turn OFF time vs. Ambient temperature


LED forward current vs. LED forward voltage


Trigger LED forward current vs. Ambient temperature


## Current leakage vs. Load voltage



## Safety Precautions

- Refer to "Common Precautions" for all G3VM models.


## Appearance

## SOP (Small Outline Package)

SOP4


Note: The actual product is marked differently from the image shown here.

* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.


## Dimensions

Surface-mounting Terminals
Weight: 0.1 g


## Actual Mounting Pad

 Dimensions(Recommended Value, TOP VIEW)


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